

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0			2023 20/04	

NOTES:

1.MATERIAL:

- 1-1.HOUSING: THORMPLASTIC,UL94-V0,COLOR :BLACK
- 1-2 THERMINAL: COPPER ALLOY,AU 30u" AT CONTACT AREA
- 1-3.SHIELD&SOLDER PLATE: STAINLESS STEEL,NI PLATED

2.ELECTRICAL CHARACTERIST;

- 2-1.RATED VOLTAGE: AC 12V;
RATED CURRENT: VBUS AND GND CONTACTS RATED AT 5A
- 2-2.CONTACT RESISTANCE(INITIAL): 30 mohms MAX;
AFTER TEST: CHANGGE OF +10 mohms MAX;
- 2-3.INSULATION RESISTANCE: 1000M ohms MIN;
- 2-4.DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTE;

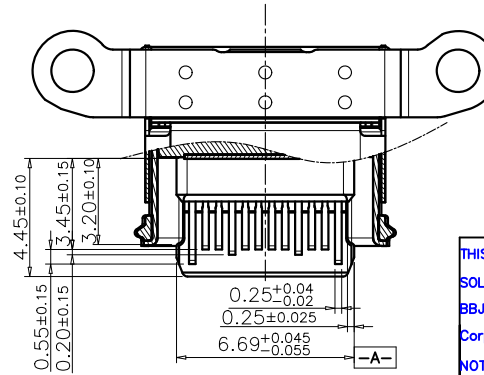
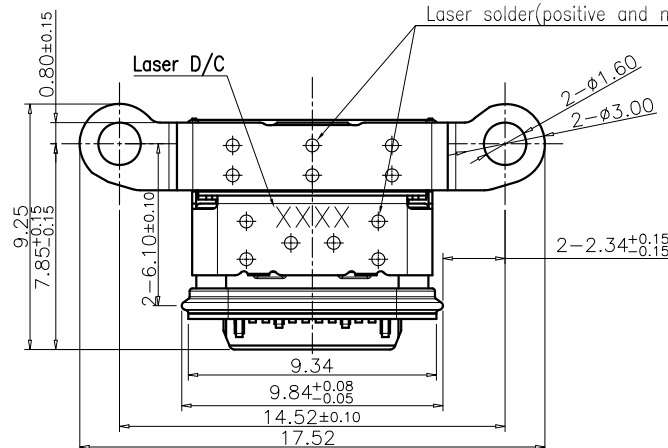
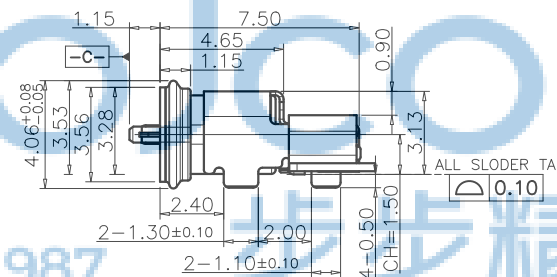
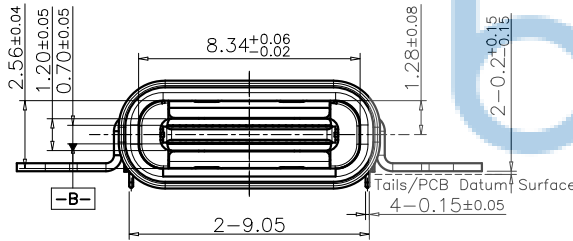
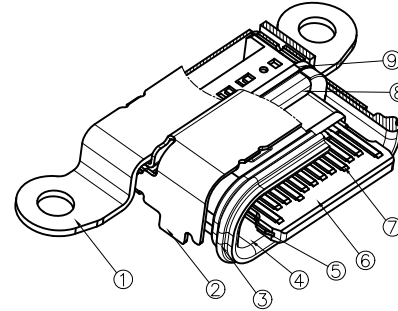
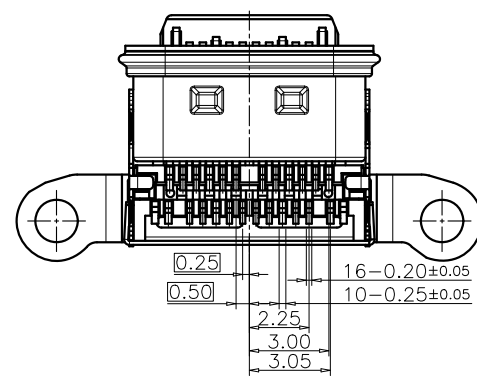
3.MECHANICAL CHARACTERIST;

- 3-1.MATING DURABILITY: 10000 CYCLES;
- 3-2.MATING FORCE: 35N MAX;
- 3-3.UNMATING FORCE: 8N MIN;

4.ENVIRONMENTAL:

- 4-1.OPERATION TEMPERATURE: -30° TO +85°
- 4-2.STORAGE TEMPERATURE RANGE: -40° TO +85°

- 5.HARMFUL MATERIAL CONTROL PLEASE FOLLOW DOC.NO."HBC-QW-030",
SHOULD BE COMPLIANCE TO REQUIREMENT ABOUT HF&RoHS&REACH.



9	GLUE	1	SILICONE	Black
8	CLAMP	2	SUS	N/A
7	CONTACT	1	Copper alloy	Ni plating on the soldering area Au plating on contact area Au plating on soldering area
6	I/M HOUSING	1	Thermoplastic	Black
5	PLATE	1	SUS	Ni plating on the soldering area
4	SHELL	1	SUS	N/A
3	O-RING	1	SILICONE	N/A
2	CLIP	1	SUS	Ni plating on the soldering area
1	PINNA	1	SUS	N/A
Item	PART NAME	QTY	Material	Treatment

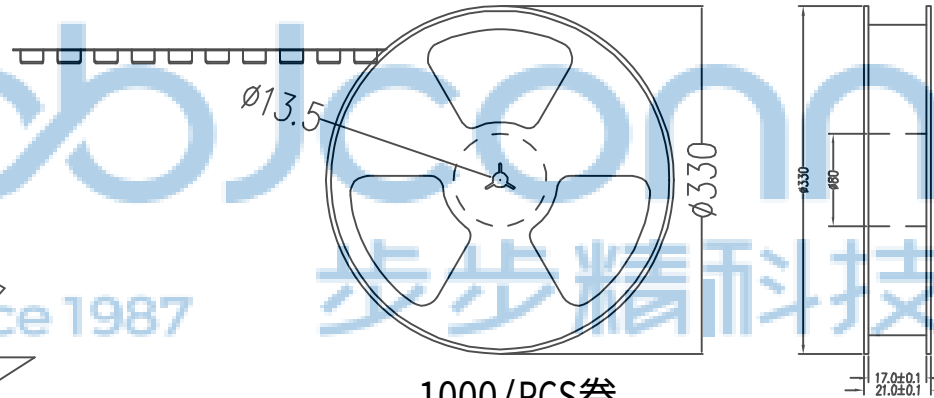
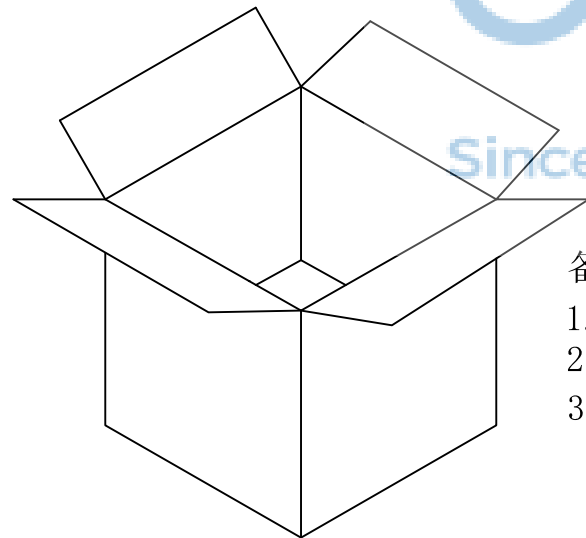
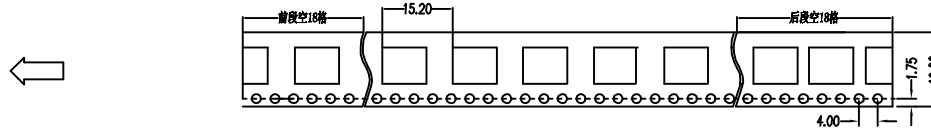
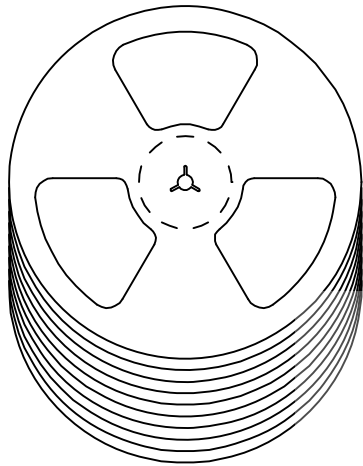
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PDWG.NO: 0332-1

深圳市步步精科技有限公司

.X: ±0.38 .XX: ±0.25 .XXX: ±0.13	X': ±3" .X': ±2" .XX': ±1"	NAME: TYPE-C 24P 防水母座 L=7.50 CH=1.50 舌片外漏1.15 板上四脚插 带锡片 端子双排SMT IPX8
APPD. JM_Zheng 23/05'02	CHKD. TSP 23/05'02	PJ. NO.: 126-221-240008-J8G SIZE: A4 DRW NO.:
DR. LYX 23/05'02	FINISH: SEE NOTES SCALE: N/A REV.: A3 UNIT: mm PAGE: 1/1	MAT'L.: SEE NOTES

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1000/PCS卷

备注:

- 包装数量: 1000/PCS/卷, 10卷/箱或15卷/箱。
- 包装袋长度: 每卷前后各空10-20个空格, 中间包装。
- 材质:
载体: 聚丙烯 (PS), 阻抗 $10^{6-9} \Omega$
上带: 聚乙烯 (PET), 阻抗 $10^{6-11} \Omega$
卷盘: 聚苯乙烯。

纸箱规格: 345*345*23MM

纸箱规格: 345*345*35MM



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